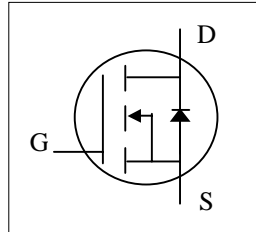




- ▼ Low Gate Charge
- ▼ Fast Switching Characteristics
- ▼ Simple Drive Requirement

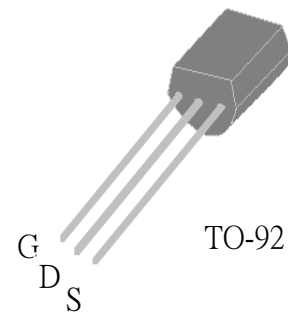


BV_{DSS}	600V
$R_{DS(ON)}$	12 Ω
I_D	160mA

Description

Advanced Power MOSFETs utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device.

The TO-92 package is widely used for commercial-industrial applications.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	600	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D @ T_A=25^\circ C$	Continuous Drain Current, V_{GS} @ 10V	160	mA
$I_D @ T_A=100^\circ C$	Continuous Drain Current, V_{GS} @ 10V	100	mA
I_{DM}	Pulsed Drain Current ¹	300	mA
$P_D @ T_A=25^\circ C$	Total Power Dissipation	0.83	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient	150	$^\circ C/W$



AP01L60AT

Electrical Characteristics @T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =1mA	600	-	-	V
ΔBV _{DSS} /ΔT _j	Breakdown Voltage Temperature Coefficient	Reference to 25°C, I _D =1mA	-	0.8	-	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =0.5A	-	-	12	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	2	-	4	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =0.5A	-	0.8	-	S
I _{DSS}	Drain-Source Leakage Current (T _j =25°C)	V _{DS} =600V, V _{GS} =0V	-	-	10	uA
	Drain-Source Leakage Current (T _j =150°C)	V _{DS} =480V, V _{GS} =0V	-	-	100	uA
I _{GSS}	Gate-Source Leakage	V _{GS} = ± 30V	-	-	±100	nA
Q _g	Total Gate Charge ²	I _D =0.1A	-	6.0	10	nC
Q _{gs}	Gate-Source Charge	V _{DS} =480V	-	1.0	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =10V	-	2.5	-	nC
t _{d(on)}	Turn-on Delay Time ²	V _{DD} =300V	-	6.6	-	ns
t _r	Rise Time	I _D =1A	-	5.0	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3Ω, V _{GS} =10V	-	11.7	-	ns
t _f	Fall Time	R _D =300Ω	-	9.2	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	170	270	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	30.7	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	5.1	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I _S	Continuous Source Current (Body Diode)	V _D =V _G =0V , V _S =1.2V	-	-	160	mA
V _{SD}	Forward On Voltage ²	I _S =160mA, V _{GS} =0V	-	-	1.2	V

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test

THIS PRODUCT IS AN ELECTROSTATIC SENSITIVE, PLEASE HANDLE WITH CAUTION.

THIS PRODUCT HAS BEEN QUALIFIED FOR CONSUMER MARKET. APPLICATIONS OR USES AS CRITERIAL COMPONENT IN LIFE SUPPORT DEVICE OR SYSTEM ARE NOT AUTHORIZED.

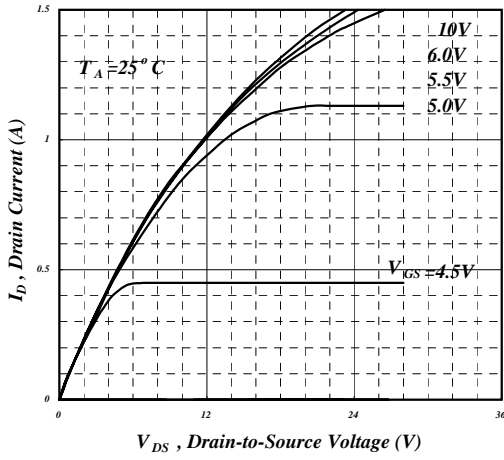


Fig 1. Typical Output Characteristics

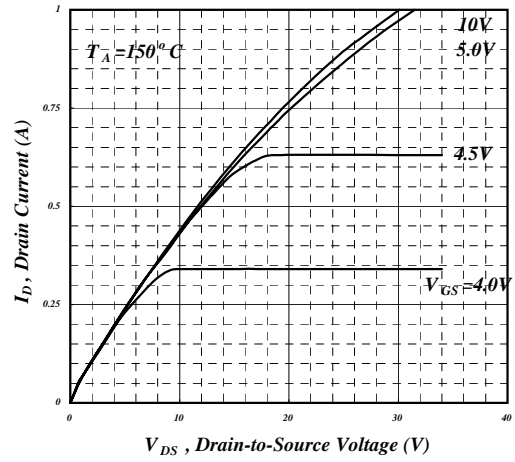


Fig 2. Typical Output Characteristics

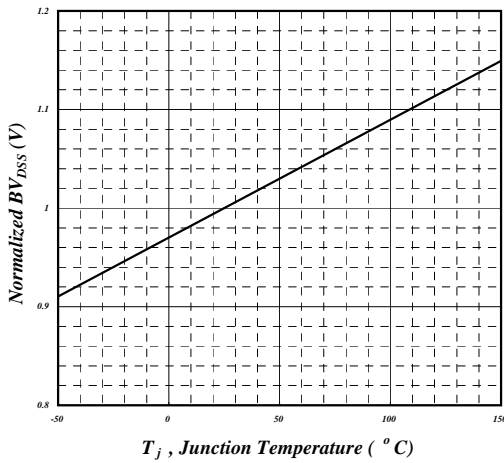


Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

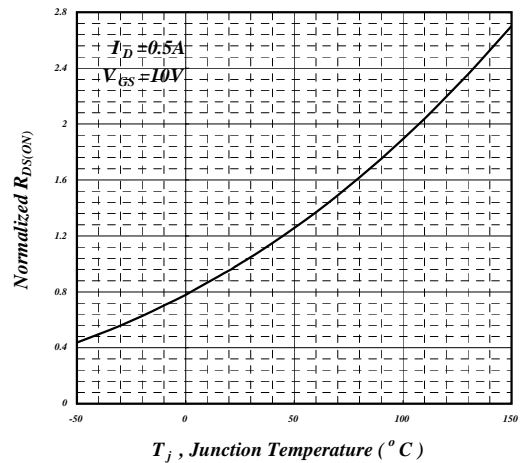


Fig 4. Normalized On-Resistance v.s. Junction Temperature

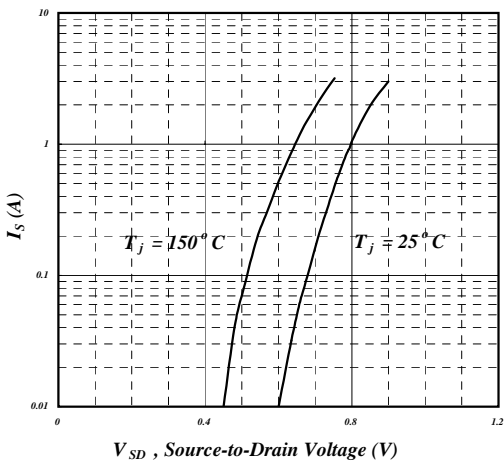


Fig 5. Forward Characteristic of Reverse Diode

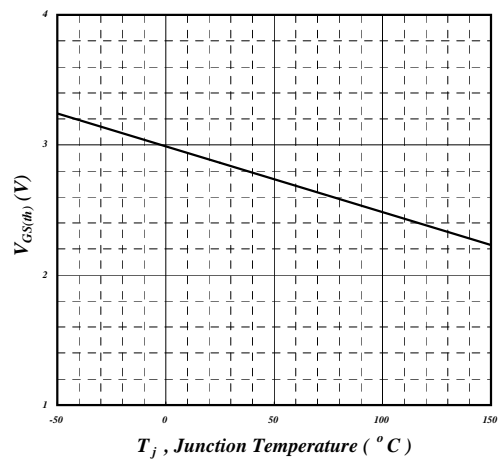


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

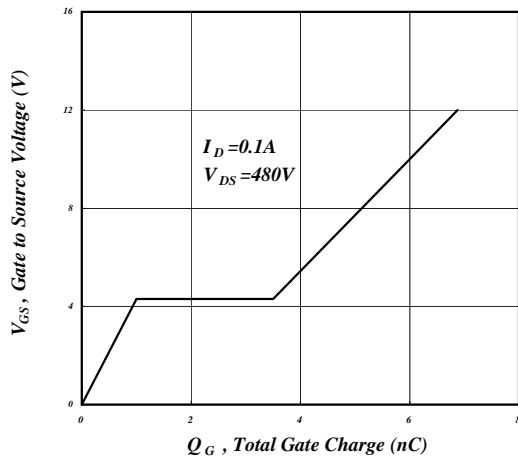


Fig 7. Gate Charge Characteristics

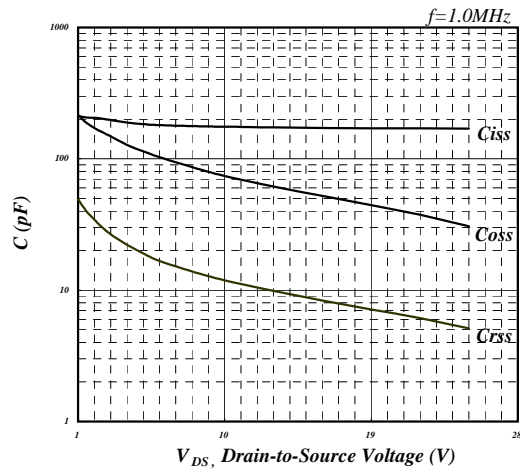


Fig 8. Typical Capacitance Characteristics

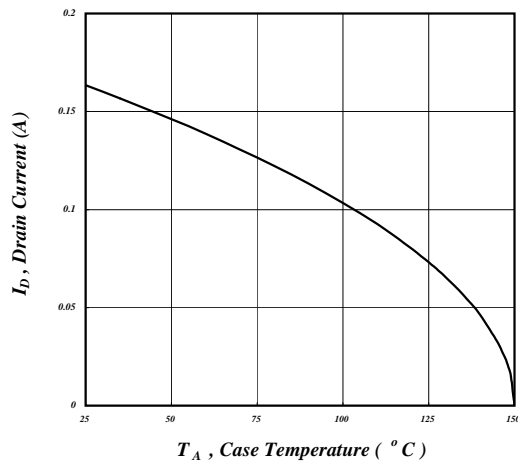


Fig 9. Maximum Drain Current v.s. Case Temperature

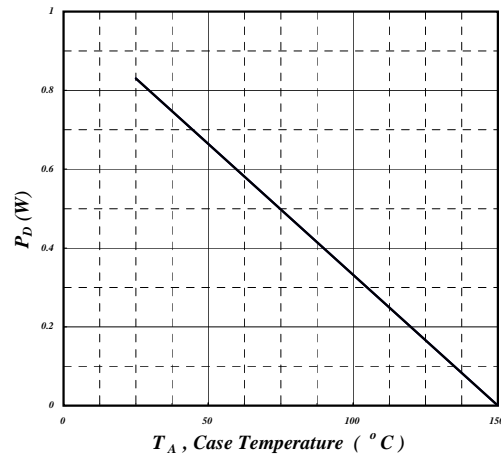


Fig 10. Typical Power Dissipation

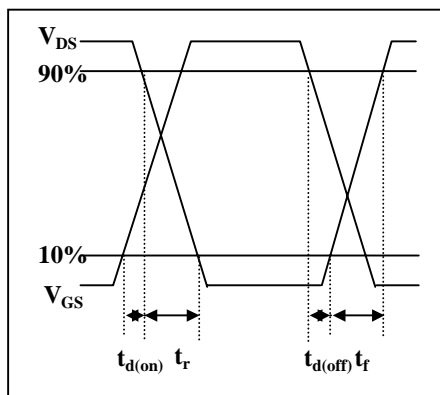


Fig 11. Switching Time Waveform

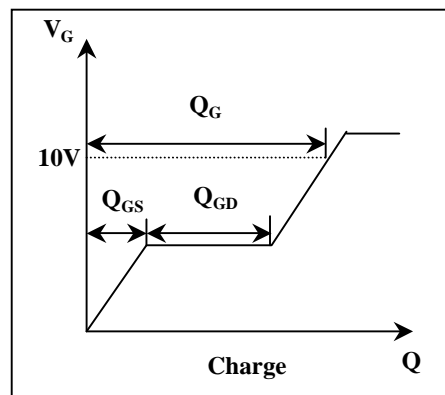
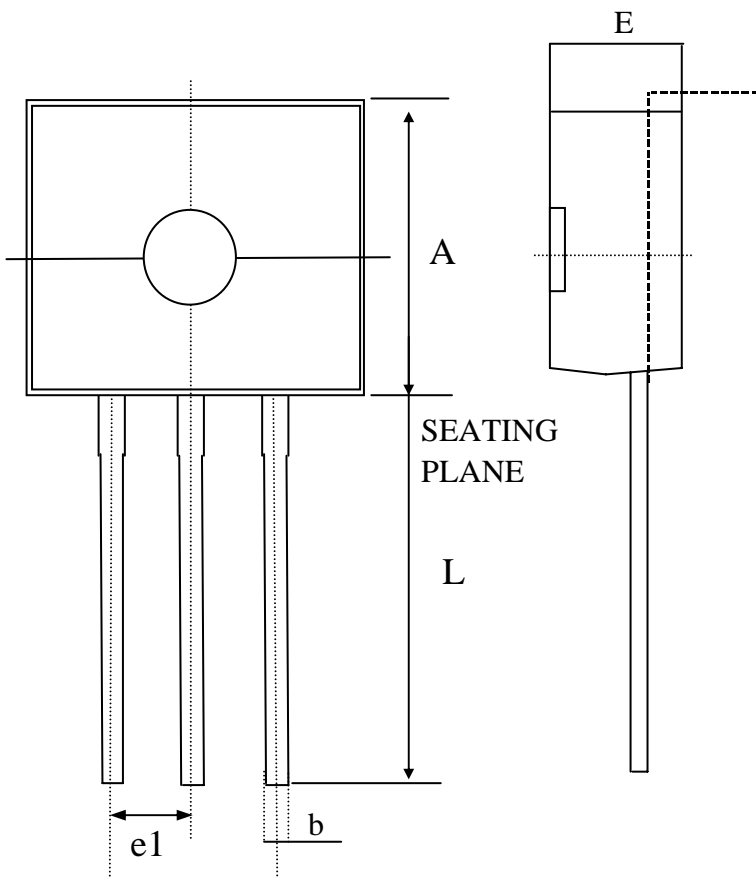


Fig 12. Gate Charge Waveform

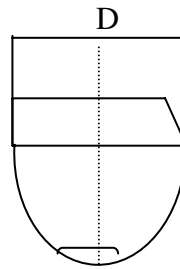


Package Outline : TO-92

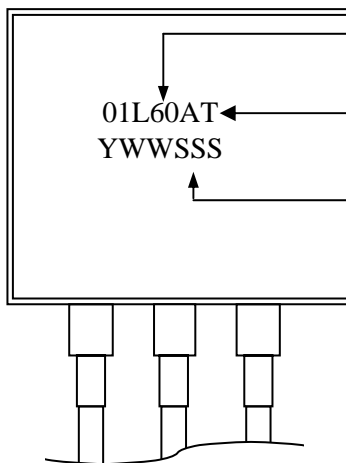


SYMBOL	Millimeters		
	MIN	NOM	MAX
A	4.32	4.83	5.34
D	4.1	4.8	5.3
E	3.1	3.9	4.7
b	----	0.38	----
L	12.7	---	----
e1	----	1.27	----

1. All Dimensions Are in Millimeters.
2. Dimension Does Not Include Mold Protrusions.



Part Marking Information & Packing : TO-92



Part Number

01L60AT
YWWSSS

Package Code

Date Code (YWWSSS)

Y : Last Digit Of The Year

WW : Week

SSS : Sequence